

SSC8LA12GT4

N-Channel Enhancement Mode MOSFET

> Features

V _{DS}	V _{GS}	R _{DS(ON)}	ID
100V	+20V	3.7mΩ@10V	150A
100 v	<u> </u>	4.9mΩ@4V5	1304

> Description

This device is N-Channel enhancement MOSFET. Uses SGT technology and design to provide excellent RDSON with low gate charge. This device is suitable for use in DC-DC conversion, power switch and charging circuit.

100% UIS + ΔVDS + Rg Tested!

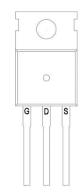
> Applications

- Motor Drive Control
- Portable Devices
- DCDC Conversion
- Power Supplies
- Synchronous Rectification

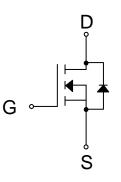
> Ordering Information

Device	Package	Shipping	
SSC8LA12GT4	TO-220-3L	50/Tube	

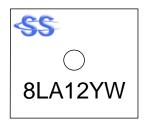
Pin Configuration



TO-220-3L (Top View)



Pin Configuration



<u>Marking</u> (YW: Internal Traceability Code)





Symbol	Parameter	Ratings	Unit		
V _{DSS}	Drain-to-Source Voltage		100	V	
V _{GSS}	Gate-to-Source Volta	ge	±20	V	
	Continuous Drain Current d	Tc =25 ℃	150		
ID	T _c =100°	Tc=100℃	69	A	
	Orationers Durin Oranata	T _A =25℃	26		
IDSM	Continuous Drain Current ^a	T _A =70℃	19	A	
IDM	Pulsed Drain Current ^b		450	A	
5		Tc=25℃	96		
PD	Power Dissipation ^c	Tc=25℃ Tc=100℃	38	W	
5	Duran Dissistantian A	T _A =25℃	4.2		
Pdsm	Power Dissipation ^a	T , =70 ℃	2.7	W	
las	Avalanche Current ^b L=0.5mH Single Pulse		45	А	
Eas	Avalanche Energy ^b L=0.5mH Single Pulse		506	mJ	
TJ	Operation junction temperature		-55~150	°C	
Tstg	Storage temperature range		-55~150	°C	

> Absolute Maximum Ratings ($T_A=25^{\circ}$ unless otherwise noted)

➤ Thermal Resistance Ratings (T_A=25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit
R _{0JA}	Junction-to-Ambient Thermal Resistance ^a	30	°C/W
R _{θJC}	Junction-to-Case Thermal Resistance	1.0	C/ V

Note:

- a. The value of R_{θJA} is measured with the device mounted on 1 in² FR-4 board with 2oz.copper, in a still air environment with T_A=25 °C.The value in any given application depends on the user is specific board design. The power dissipation is based on the t≤10s thermal resistance rating.
- b. Repetitive rating, pulse width limited by junction temperature.
- c. The power dissipation P_D is based on T_{J(MAX)}=150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.
- d. The maximum current rating is package limited.



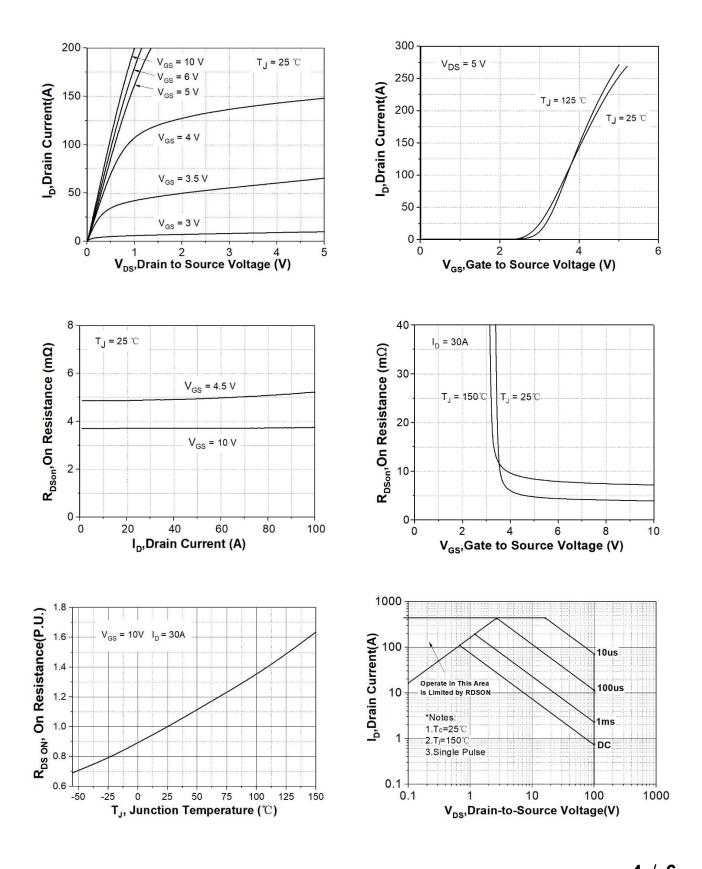


\succ Electrical Characteristics (T_A=25 °C unless otherwise noted)

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250µA	100			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = 250 uA$	1.4	2	2.5	V
Drain Source On Desistance	Dear	V _{GS} = 10V, I _D = 30A		3.7	5	
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} = 4.5V, I _D = 20A		4.9	7.5	mΩ
Zero Gate Voltage Drain Current	loss	V _{DS} = 80V, V _{GS} = 0V			1	μA
Gate-Source Leak Current	lgss	V_{GS} = ±20V, V_{DS} = 0V			±100	nA
Transconductance	G _{FS}	V _{DS} = 5V, I _D = 20A		60		s
Forward Voltage	Vsd	V _{GS} = 0V, I _S = 20A		0.8	1.3	V
Gate Resistance	R _G	V _{DS} = 0V, f = 1MHz		2.7		Ω
Input Capacitance	Ciss	$\lambda = 50 \lambda \lambda = 0 \lambda$		4560		
Output Capacitance	Coss	$V_{DS} = 50V, V_{GS} = 0V,$ f = 1MHz		674		pF
Reverse Transfer Capacitance	Crss			31		
Total Gate Charge	Q _G			64		
Gate to Source Charge	Q _{GS}	$V_{\rm GS} = 10V, V_{\rm DS} = 50V,$		15		nC
Gate to Drain Charge	Q_{GD}	I _D = 20A		11		
Turn-on Delay Time	T _{D(ON)}			22		
Rise Time	Tr	V _{GS} = 10V, V _{DS} = 50V,		27		
Turn-off Delay Time	T _{D(OFF)}	R _L = 2.5Ω, R _G = 3Ω		66		ns
Fall Time	T _f			73		
Diode Recovery Time	Trr	I⊧=20A, di/dt=100A/us		50		ns
Diode Recovery Charge	Q _{rr}	I _F =20A, di/dt=100A/us		110		nC



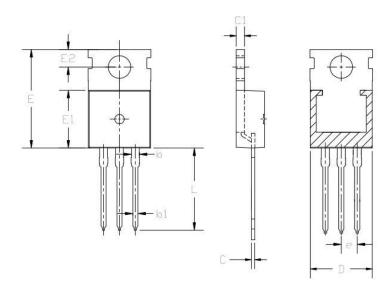
> Typical Performance Characteristics (T_A=25 $^{\circ}$ C unless otherwise noted)



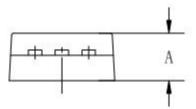


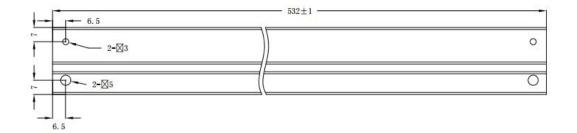
SSC8LA12GT4

> Package Information

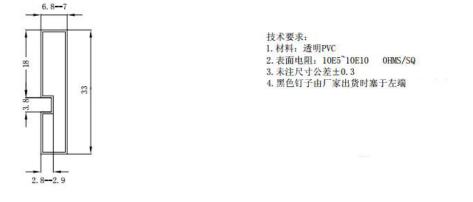


aumou	MILLIMETER			
SYMBOL	MIN	NOM	MAX	
A	4.40		4.60	
b	1.20	100000	1.36	
b1	0.70	1222	0.90	
C	0.48	-	0.53	
C1	1.28	1000	1.32	
D	9.80	10.00	10.20	
E	15.20	15,45	15,75	
E1	9.00	9.20	9.40	
E2	2.6.0	10.773	2.90	
e		2.54	1000	
L	13.00		13,40	





 $T=0.5 \pm 0.1$





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